

# **GBPC 12, 15, 25, 35 SERIES**

### **Features**

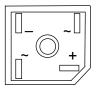
- Integrally molded heatsink provided very low thermal resistance for maximum heat dissipation.
- · Surge overload rartings from 300 amperes to 400 amperes.
- · Isolated voltage from case to lead over 2500 volts.
- UL certified, UL #E96005.







**GBPC** 





Wire Lead Structure

## Suffix "M"

Terminal Location Face to Face

# **Bridge Rectifiers (Glass Passivated)**

#### **Absolute Maximum Ratings\*** T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value						Units	
		005	01	02	04	06	08	10	
V <sub>RRM</sub>	Maximum Repetitive Reverse Voltage	50	100	200	400	600	800	1000	V
V <sub>RMS</sub>	Maximum RMS Bridge Input Voltage		70	140	280	420	560	700	V
V <sub>R</sub>	DC Reverse Voltage (Rated V <sub>R</sub> )	50	100	200	400	600	800	1000	V
I <sub>F(AV)</sub>	Average Rectified Forward Current  @ T <sub>A</sub> = 55°C GBPC12 GBPC15 GBPC25 GBPC35				12 15 25 35				A A A
I <sub>FSM</sub>	Non-repetitive Peak Forward Surge Current GBPC12, 15, 25 8.3 ms Single Half-Sine-Wave GBPC35		300 400						A A
T <sub>stq</sub>	Storage Temperature Range		-55 to +150					°C	
T <sub>J</sub>	Operating Junction Temperature			-55 to +150				°C	

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

# **Bridge Rectifiers (Glass Passivated)**

(continued)

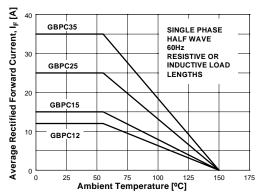
## **Thermal Characteristics**

Symbol	Parameter	Value	Units	
$P_{D}$	Power Dissipation	83.3	W	
R <sub>eJL</sub>	Thermal Resistance, Junction to Lead	1.5	°C/W	

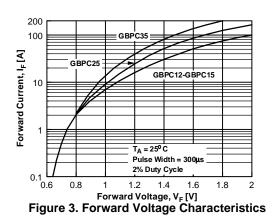
<b>Electrical Characteristics</b>	T <sub>A</sub> = 25°C unless otherwise noted
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Symbol	Parameter	Device	Units
V <sub>F</sub>	Forward Voltage Drop, per bridge @ 6.0 A GBPC12 @ 7.5 A GBPC15 @ 12.5 A GBPC25 @ 17.5 A GBPC35	1.1	V
I <sub>R</sub>	Reverse Current, per leg @ rated $V_R$ $T_A = 25^{\circ}C$ $T_A = 125^{\circ}C$	5.0 500	μA μA
	I <sup>2</sup> t rating for fusing t < 8.3 ms <b>GBPC12, 15, 25</b> <b>GBPC35</b>	375 660	A <sup>2</sup> Sec A <sup>2</sup> Sec
Ст		180 200	pF pF

# **Typical Characteristics**



**Figure 1. Forward Current Derating Curve** 



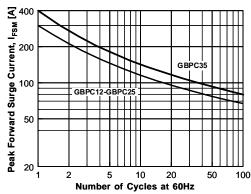


Figure 2. Non-Repetitive Surge Current

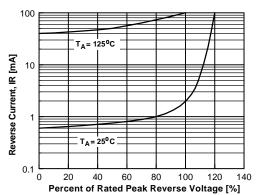


Figure 4. Reverse Current vs Reverse Voltage

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